8-215079-8 ACTIVE

Micro-MaTch | Micro-MaTch Industrial

TE Internal #: 8-215079-8

Board-to-Board, 18 Position, 1.27 mm [.05 in] Centerline, Vertical, Through Hole - Solder, 2 Row, Micro-MaTch Industrial, Ribbon

Cable Connectors

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors > Female-on-Board Connector, Top Entry











Connector System: Board-to-Board

Number of Positions: 18

Centerline (Pitch): 1.27 mm [.05 in]

PCB Mount Retention: With

PCB Mount Retention Type: Kinked Solder Tails

All Female-on-Board Connector, Top Entry (67)

Features

Product Type Features

Connector Product Type	Connector Assembly
Ribbon Cable Connector Type	Female-on-Board
Ribbon Cable Connector Header Type	Shrouded
Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	18
PCB Mount Orientation	Vertical
Number of Rows	2

Operating Voltage	100 VDC



Insulation Resistance	1000 ΜΩ
Body Features	
Daisy Chain	Without
Primary Product Color	Red
Connector Profile	Standard
Contact Features	
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Shape & Form	Dual Beam
PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Mating Area Plating Material	Tin (Sn)
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Type	Socket
Contact Current Rating (Max)	1 A
Termination Features	
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Contact Retention Type Within Housing	Press-Fit
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Kinked Solder Tails
Mating Retention	With
Mating Retention Type	Contact Friction
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор



Housing Material	PBT GF
Centerline (Pitch)	1.27 mm[.05 in]
Dimensions	
PCB Thickness (Recommended)	1.6 mm[.062 in]
Connector Height	4 mm[.16 in]
Connector Length	24.9 mm[.98 in]
Row-to-Row Spacing	2 mm[.059 in]
Usage Conditions	
Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Compatible With Agency/Standards Products	UL
UL Rating	Recognized
UL Flammability Rating	UL 94V-0
Compatible With Approved Standards Products	UL E28476
Packaging Features	
Packaging Quantity	250

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Box & Carton



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





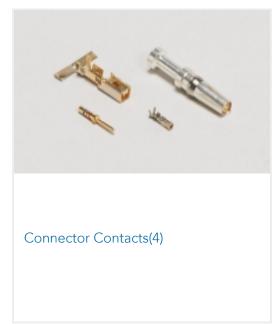


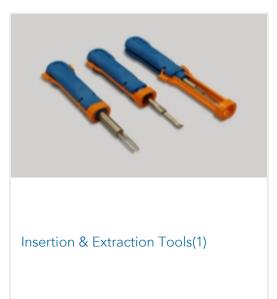




Also in the Series | Micro-MaTch Industrial

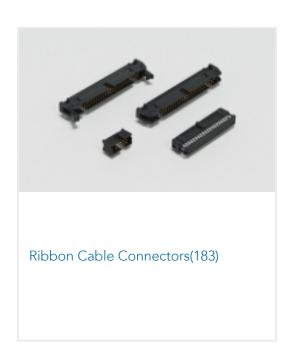












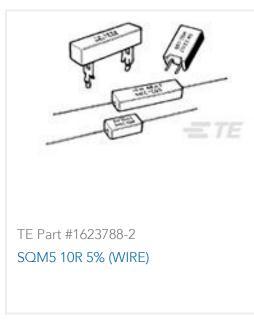
Customers Also Bought





















Documents

Product Drawings
MICRO-MATCH FOB.18P

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_8-215079-8_T.2d_dxf.zip

Board-to-Board, 18 Position, 1.27 mm [.05 in] Centerline, Vertical, Through Hole - Solder, 2 Row, Micro-MaTch Industrial, Ribbon Cable Connectors



English

Customer View Model

ENG_CVM_CVM_8-215079-8_T.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_8-215079-8_T.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Micro-MaTch Catalog

English

Ribbon Cable Interconnect Solutions

English

Centerline Micro-Match Connector Series

English

Product Specifications

Product Specification

English

Agency Approvals

UL Report

English